

FEATURES

- RDS(ON)<1.5Ω @ VGS=10V
- Fast switching capability
- Low gate charge
- Lead free in compliance with EU RoHS directive.
- Green molding compound

MECHANICAL DATA

- Case:TO-220,ITO-220,TO-263 Package

Ordering Information

Part No.	Package	Packing
6N65-TU	TO-220	50pcs / Tube
6N65F-TU	ITO-220	50pcs / Tube
6N65D-TU	TO-262	50pcs / Tube

PRODUCT SUMMARY

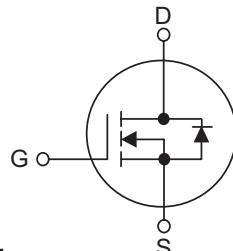
V _{DS} (V)	R _{D(S(on))} (Ω)	I _D (A)
650	1.5 @ V _{GS} =10V	6



Pin Definition:

1. Gate
2. Drain
3. Source

Block Diagram



ABSOLUTE MAXIMUM RATINGS (T_C=25 C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	650	V
Gate-Source Voltage		V _{GSS}	30	V
Continuous Drain Current		I _D	6	A
Pulsed Drain Current (Note 2)		I _{DM}	28	A
Avalanche Energy		E _{AS}	435	mJ
Power Dissipation	TO-220/TO-263	P _D	142	W
	ITO-220		48	W
Junction Temperature		T _J	+150	C
Storage Temperature		T _{STG}	-55 ~ +150	C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by T_J

3. L = 30mH, I_{AS} = 5.25A, V_{DD} = 50V, R_G = 25 Ω, Starting T_J = 25 C

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650V N-Channel Power MOSFET

THERMAL DATA

PARAMETER	SYMBOL	RATING	UNIT
Junction to Ambient TO-220/ITO-220 TO-263	$R_{\theta JA}$	62.5	C/W
Junction to Case TO-220/TO-263 ITO-220	$R_{\theta JC}$	0.90	C/W
		2.6	

ELECTRICAL CHARACTERISTICS (T_C=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=200\mu A$	650			V
Drain-Source Leakage Current	$I_{DS(on)}$	$V_{DS}=650V, V_{GS}=0V$			1	μA
Gate- Source Leakage Current	Forward	$V_G=30V, V_{DS}=0V$			100	nA
	Reverse	$V_{GS}=-30V, V_{DS}=0V$			-100	nA
Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS} / \Delta T_J$	$I_D=250\mu A$, Referenced to 25°C	0.67			V/C
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=3.5A$		1.35	1.5	Ω
DYNAMIC CHARACTERISTICS						
Input Capacitance	C_{ISS}	$V_{DS}=25V, V_{GS}=0V, f=1MHz$		1210	1400	pF
Output Capacitance	C_{OSS}			140	180	pF
Reverse Transfer Capacitance	C_{RSS}			40	50	pF
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	$t_{D(ON)}$	$V_{DD}=300V, I_D=6A$ $R_G=25\Omega$ (Note 1, 2)		50	70	ns
Turn-On Rise Time	t_R			150	180	ns
Turn-Off Delay Time	$t_{D(OFF)}$			380	410	ns
Turn-Off Fall Time	t_F			180	220	ns
Total Gate Charge	Q_G	$V_{DS}=520V, I_D=6A$ $V_{GS}=10V$ (Note 1, 2)		29	38	nC
Gate-Source Charge	Q_{GS}			9		nC
Gate-Drain Charge	Q_{GD}			19		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
Drain-Source Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_S=6$			1.4	V
Maximum Continuous Drain-Source Diode Forward Current	I_S				7	A
Maximum Pulsed Drain-Source Diode Forward Current	I_{SM}				28	A
Reverse Recovery Time	t_{rr}	$V_{GS}=0V, I_S=6$ $dI/dt=100A/\mu s$ (Note 1)		490		ns
Reverse Recovery Charge	Q_{RR}			3.2		μC

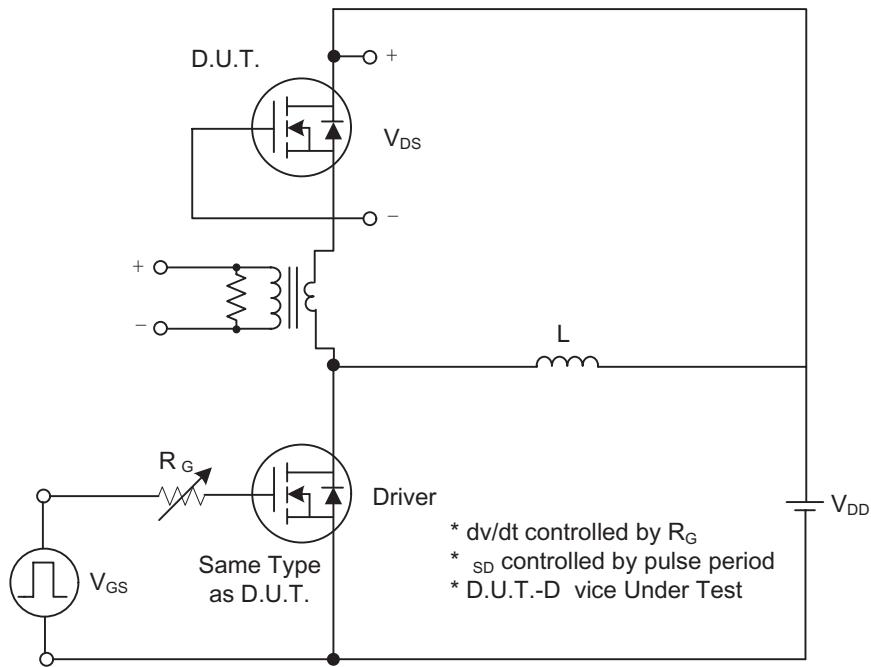
Notes: 1. Pulse Test: Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$.

2. Essentially independent of operating temperature.

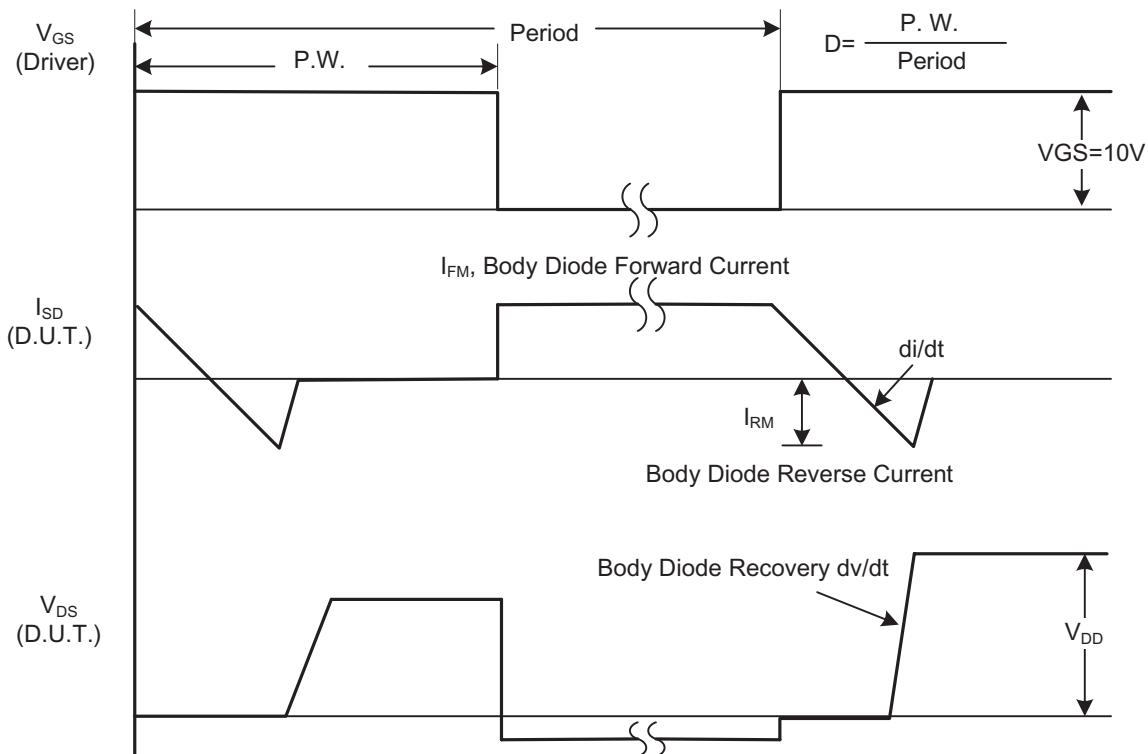
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TEST CIRCUITS AND WAVEFORMS



Peak Diode Recovery dv/dt Test Circuit

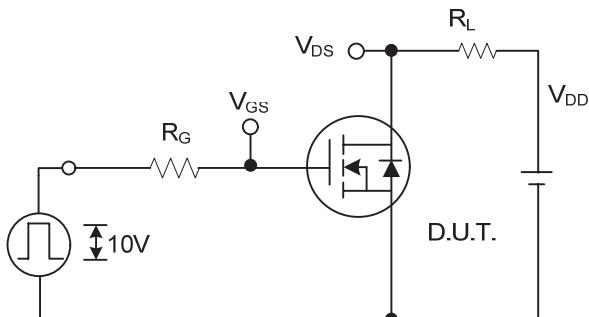


Peak Diode Recovery dv/dt Waveforms

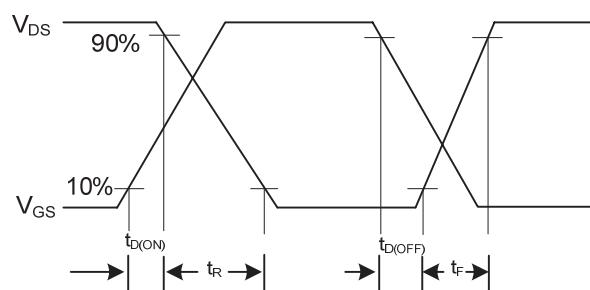
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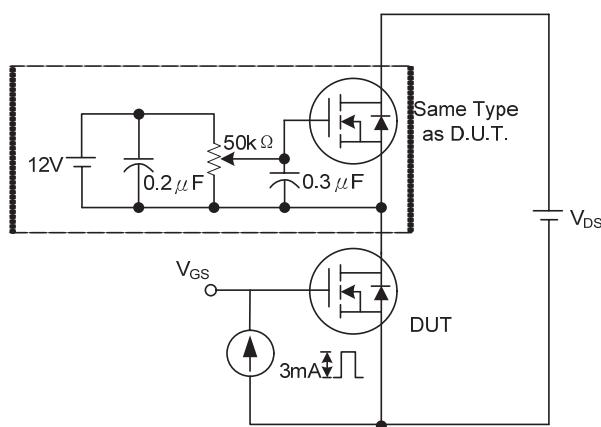
TEST CIRCUITS AND WAVEFORMS(Cont.)



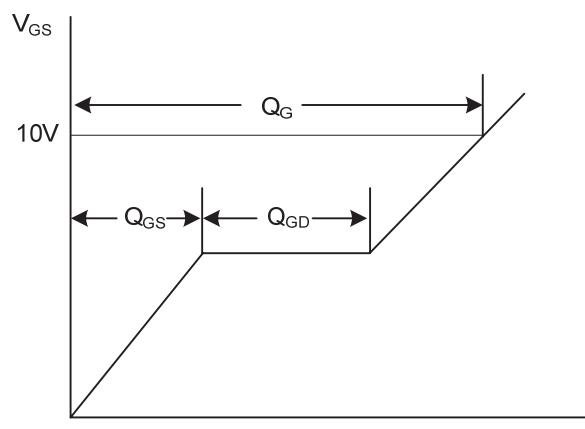
Switching Test Circuit



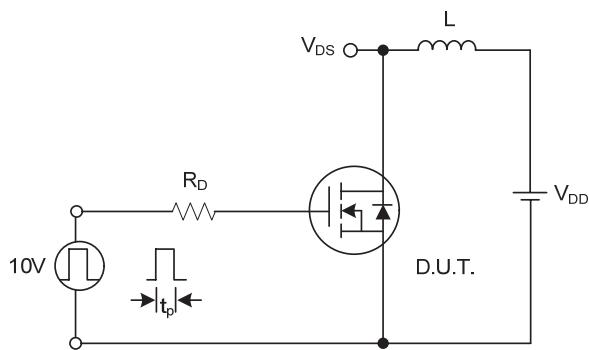
Switching Waveforms



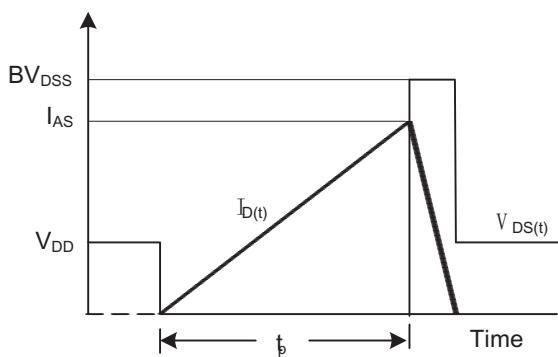
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



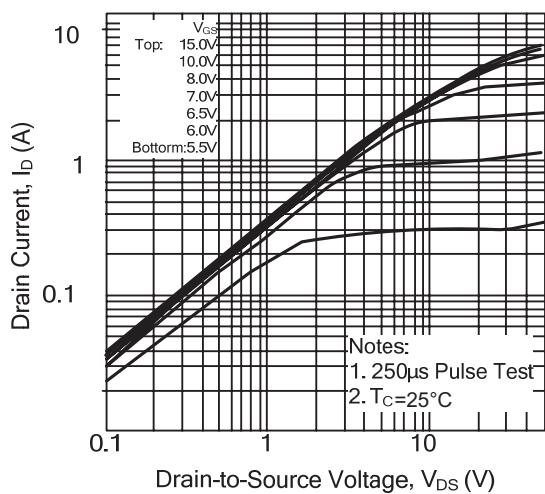
Unclamped Inductive Switching Waveforms

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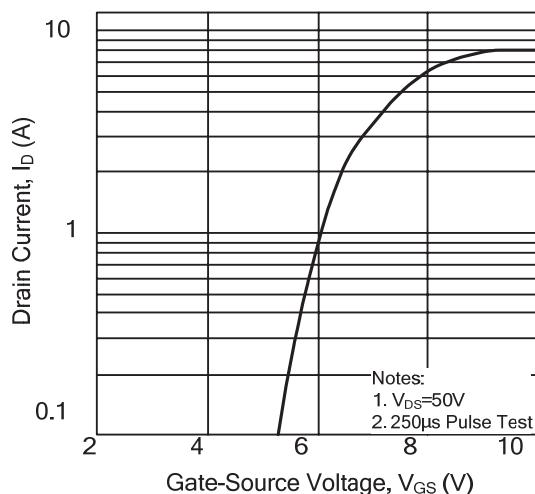
650V N-Channel Power MOSFET

TYPICAL CHARACTERISTICS

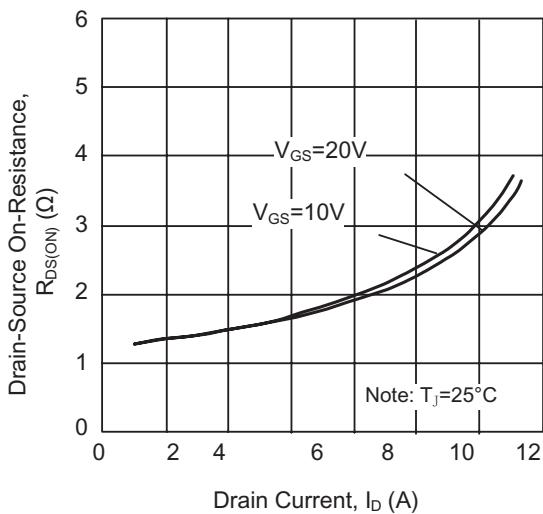
On-State Characteristics



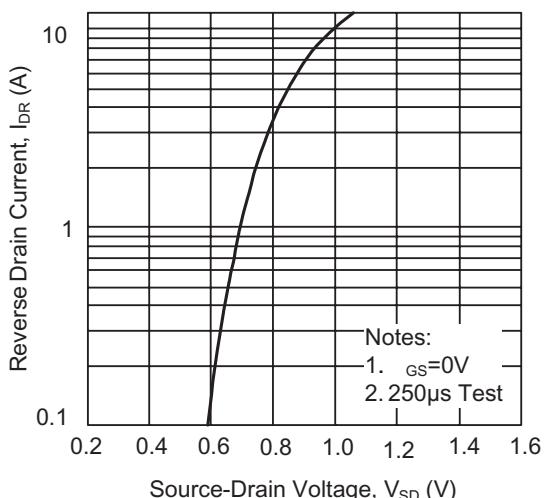
Transfer Characteristics



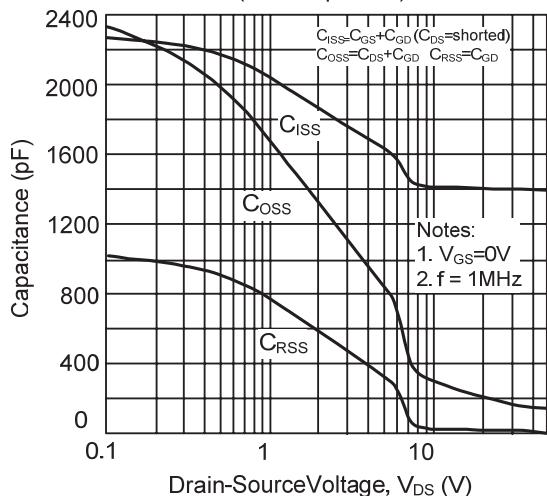
On-Resistance Variation vs.
Drain Current and Gate Voltage



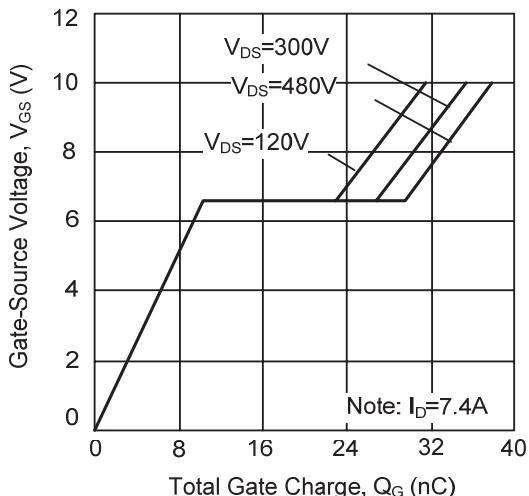
On State Current vs.
Allowable Case Temperature



Capacitance Characteristics
(Non-Repetitive)



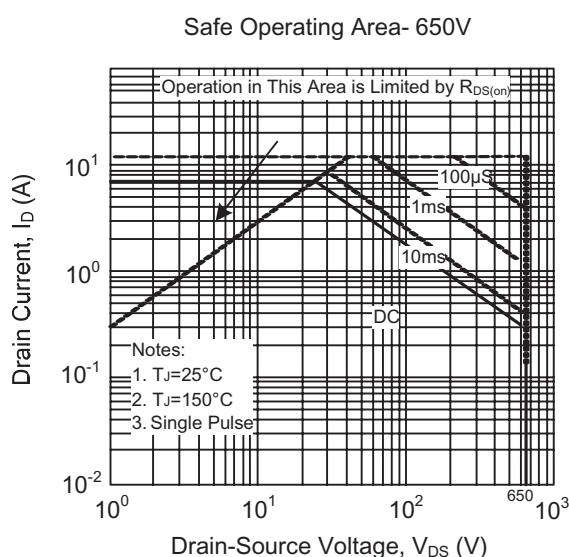
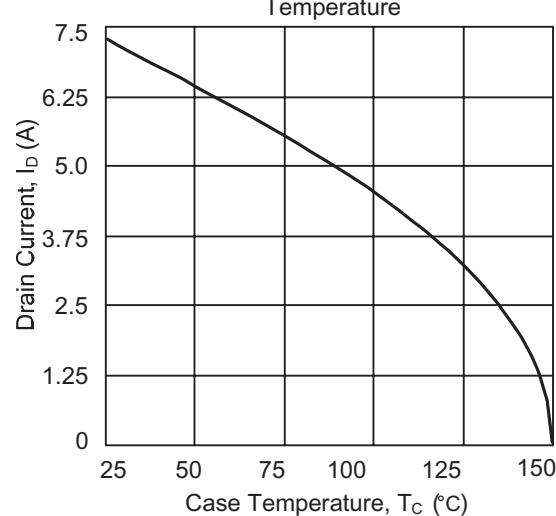
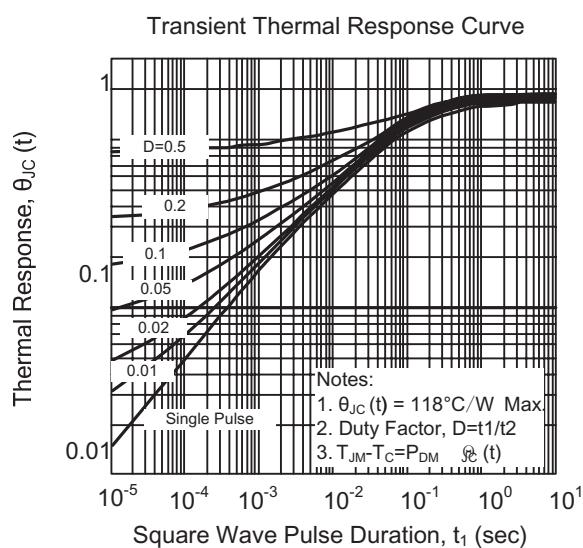
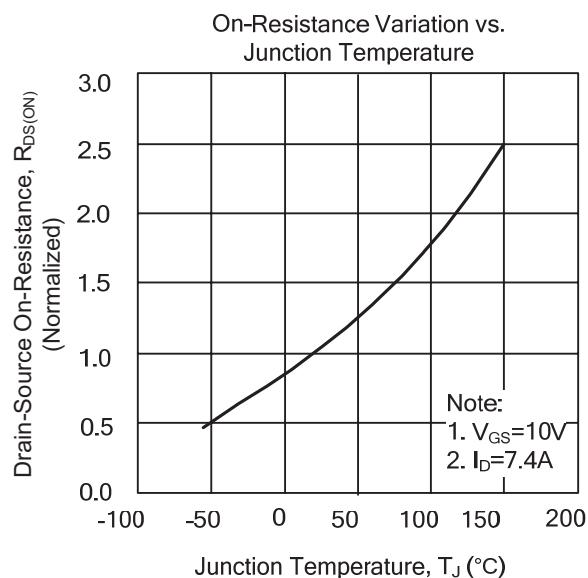
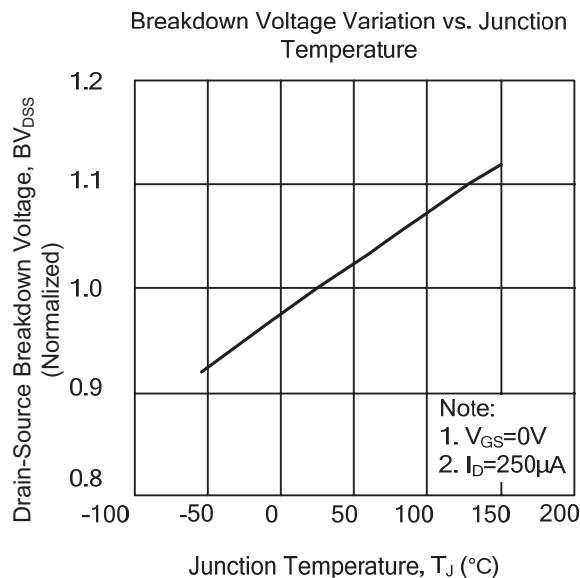
Gate Charge Characteristics



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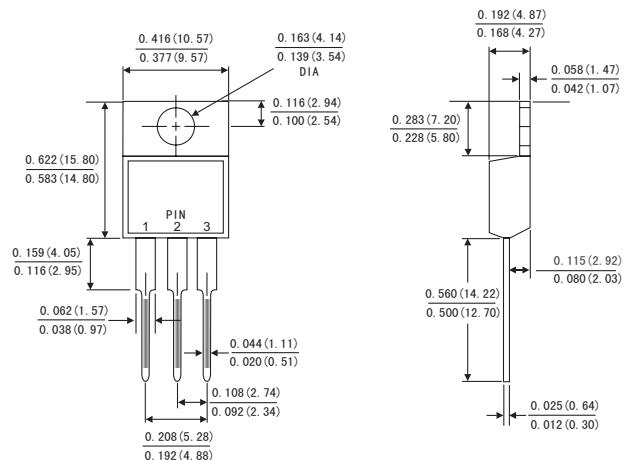
TYPICAL CHARACTERISTICS



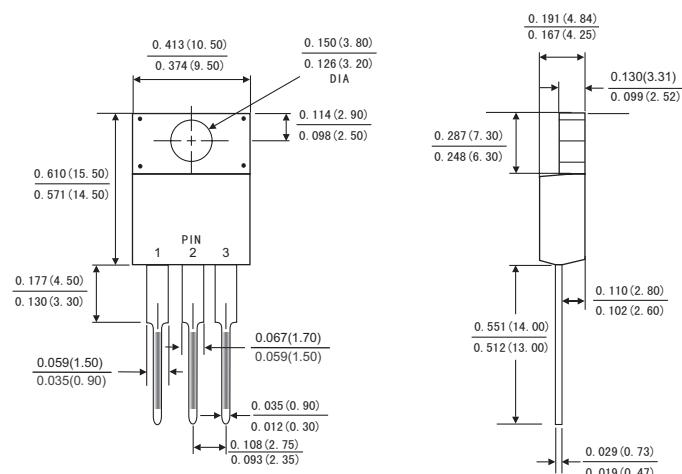
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650V N-Channel Power MOSFET

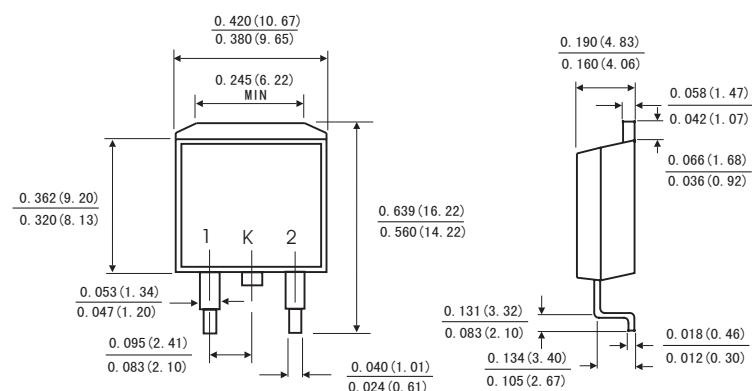
TO-220AB



ITO-220AB



TO-263



Dimensions in inches and (millimeters)